

ZIGEN LED DATASHEET

Series Part Number

ZG7BGX_{xx}W00

ON BBL Tunable White
patented Technology by ZIGEN

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1. Product Description

ZIGEN is targeting to professional lighting market from innovative concepts and quality driven development.

ZG7BxxxW00 is under ZIGEN VII series (ZG7) with features below

- Mechanical Dimensions : 12.0 x 15.0 x 1.4 (mm)
- Tunable white COB, followed on BBL
(note: there is condition to make CCT change on BBL. PWM dual channel output driver will not achieve on BBL CCT output)
- Starting from comfortable CCT (below 2700K) to make nice lighting effect
- Narrow color control to provide stable color performance
- 3 point color check to provide precise color control
- Keep enough power input at both CCT end
- Substrate : Alumina Ceramic

ZG7 B G x xx W 0 0
 [1] [2] [3] [4] [5] [6] [7] [8]

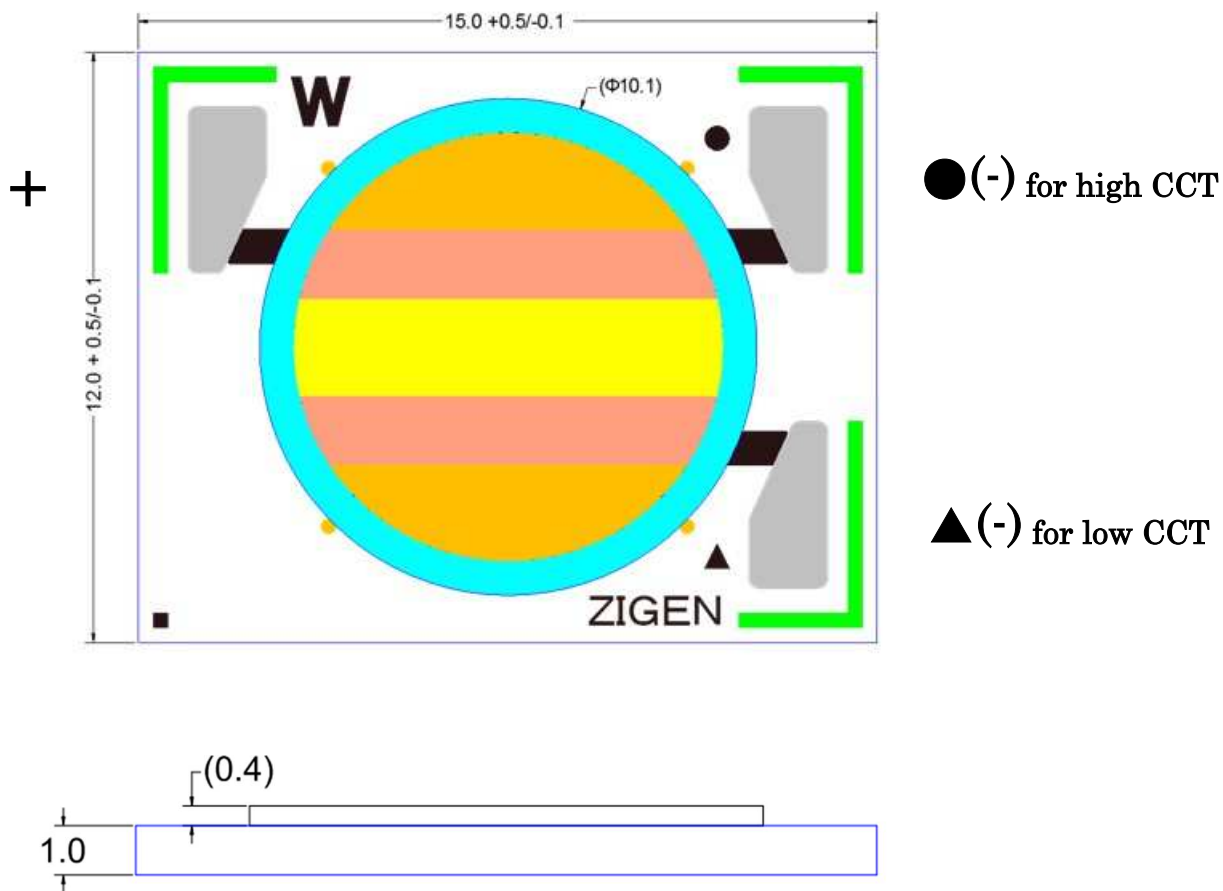
[1]	Series code	ZG7
[2]	Substrate size	B (15x12mm)
[3]	CRI	G (>90)
[4]	Chip Layout	X (6series)
[5]	Color code	L5 (2200K-5000K) 24 (2000K-4000K)
[6]	LES	W (8.7mm, ZG6)
[7]	Test Condition	0 (cold)
[8]	Custom code	0

2. External Dimension & Circuit Diagram

- External Dimension

Unit : mm

Tolerances unless specified : +/-0.1



- Notes:
- Values inside parentheses are reference values.
 - External sizes of are determined by maximum dimensions, that include salient areas on the edges of respective sides.
 - Distance from bottom of substrate to electrode is typical 2.0mm (reference)
 - Inner edge of green line is designed to have distance >1.2mm from bottom of substrate.

3. Ratings and Characteristics

3-1) Absolute maximum ratings

Parameter	Symbol	Ratings	Unit
Max. DC Forward Current (mA) ※1,4	I _F	650	mA
Power Dissipation ※1,4	P _d	11.5 for BGX	W
Reverse Voltage ※2,4	V _R	-15	V
Max. Junction Temperature	T _j	145	°C
Operating Temperature ※3	T _{Opr}	-30 ~ +100	°C
Storage Temperature	T _{Stg}	-40 ~ +100	°C

Notes:

- ※ 1. Power dissipation and forward current are the values when the module temperature is set lower than the rating by using an adequate heat sink.
- ※ 2. The maximum rating of reverse voltage is assumed to happen in short time by the initial connection error.
(Not dealing with the possibility of always-on reverse voltage.)
- ※ 3. Operating temperature is the Case temperature T_c
(Refer to measuring point for case temperature in the next page.)
Refer "Derating curve" in the 3-4) for Operating temperature at operating current.
- ※ 4. T_c=25°C or within derating curve temperature at operating current.

3-2) Electro-Optical Characteristics

(Measured at 500mA, T_j=25°C)

Product Code	Wire Connection	Nomical CCT	CRI (Ra)		Luminous Flux		Voltage		
			Min.	Typ	Min.	Typ.	Min.	Typ.	Max.
ZG7BGX L5W00	▲	2200	85	88	810	900	16.0	17.6	19.0
	▲+●	3600	90	95	920	1020	15.6	17.0	18.6
	●	5000	90	93	830	920	16.0	17.6	19.0
ZG7BGX 24W00	▲	2000	85	88	740	820	16.0	17.6	19.0
	▲+●	3100	90	95	880	970	15.6	17.0	18.6
	●	4000	90	93	860	950	16.0	17.6	19.0

Notes:

- ※ 5. Measurement tolerance: Voltage ± 3 %, Luminous Flux ±7%, Ra ±2

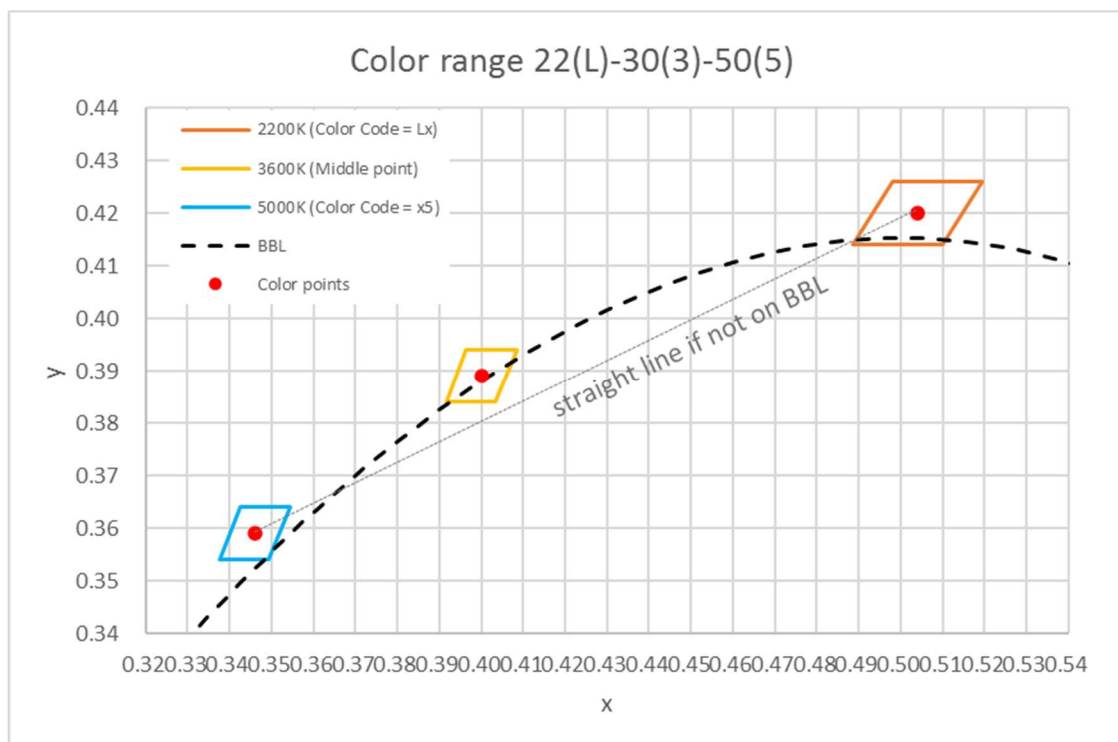
3-3) Chromaticity Characteristics

(Measured at 500mA)
 x,y tolerance : +/- 0.005
 Tj=25 degree

2200K	x	0.5194	0.4980	0.4887	0.5101
(Color Code = Lx)	y	0.4260	0.4260	0.4140	0.4140

3600K	x	0.3917	0.4034	0.4084	0.3964
(Middle point)	y	0.3840	0.3840	0.3940	0.3940

5000K	x	0.3377	0.3494	0.3544	0.3424
(Color Code = x5)	y	0.3540	0.3540	0.3640	0.3640



3-4) Derating Curve

To keep the LED in good reliability use, Case temperature (T_c) of COB must be below the rating curve by attaching an adequate heat sink.

Please measure T_c in actual usage condition.

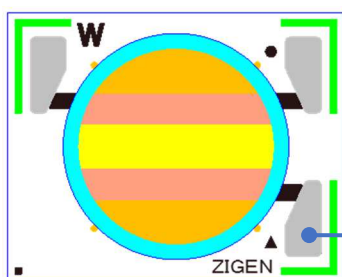
Below T_c derating curve is only applicable to right condition of installation written in precautions.

Especially heat sink surface must be flat on backside of COB and well thermally conducted.

If heatsink under T_c point of COB is not flat, please use the different point on COB with same distance from center of LES as T_c point.

Please ensure that T_c does not exceed derating curve even after installation and operation as final product.

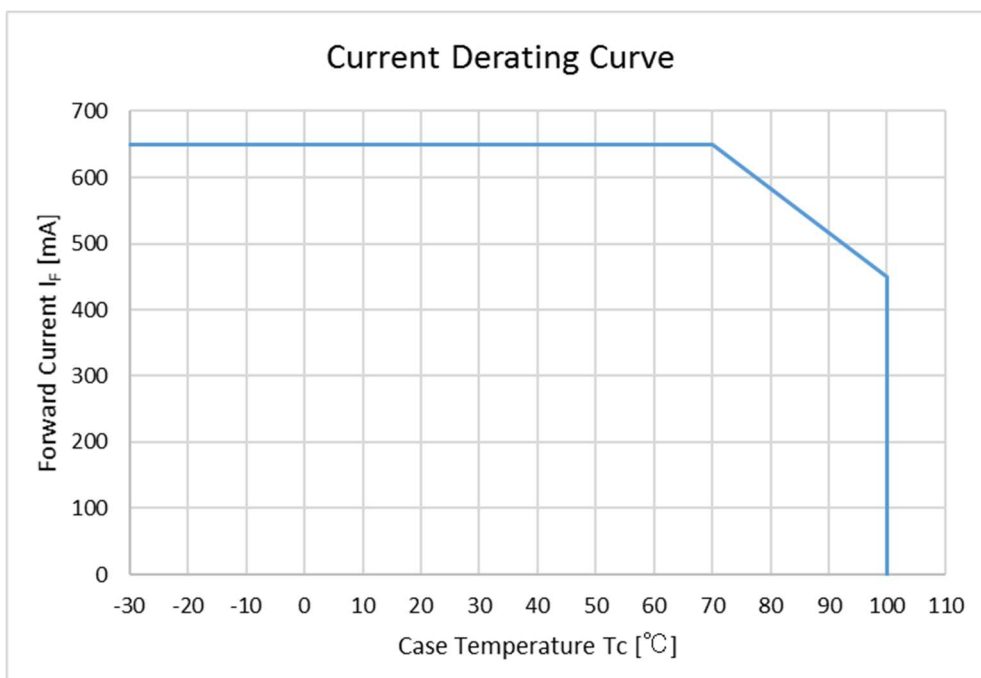
(Measuring point for case temperature)



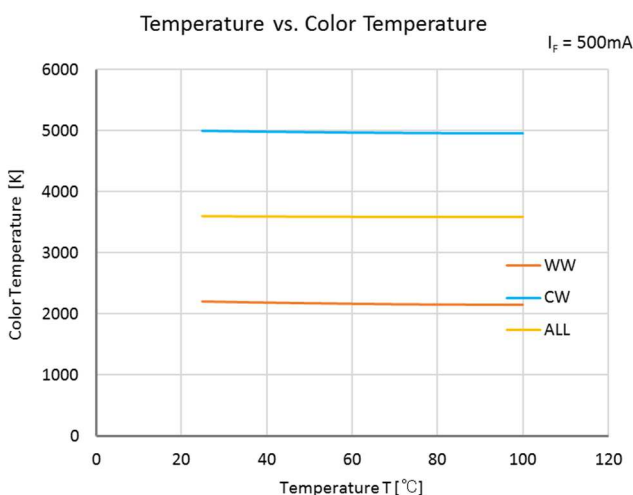
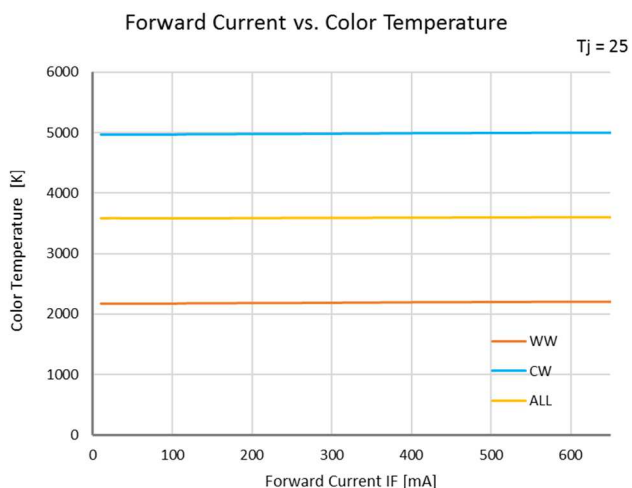
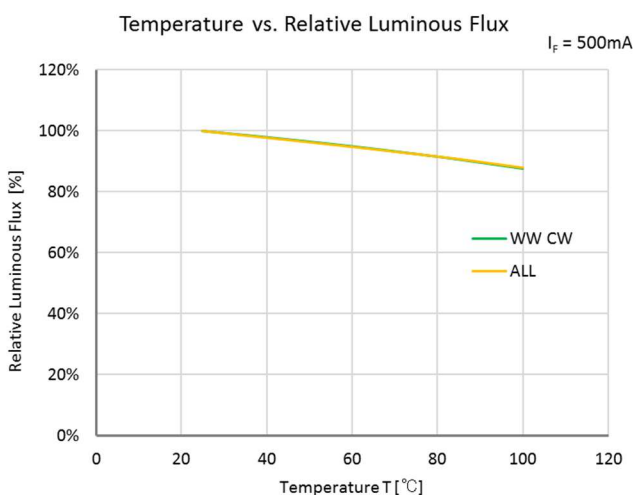
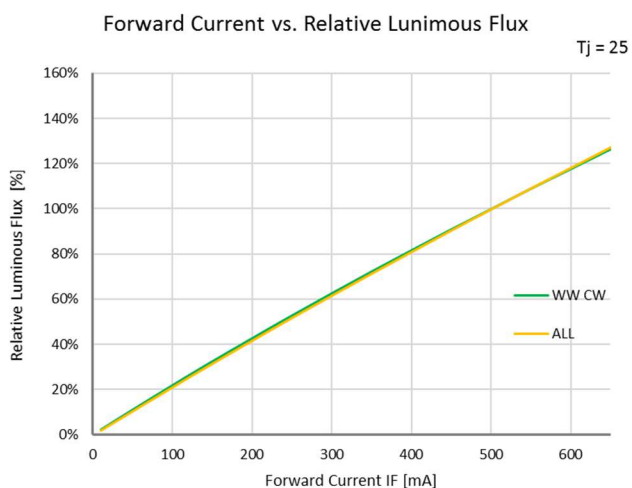
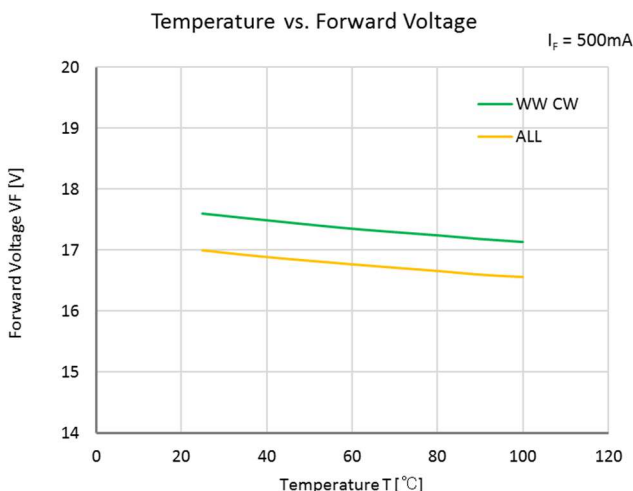
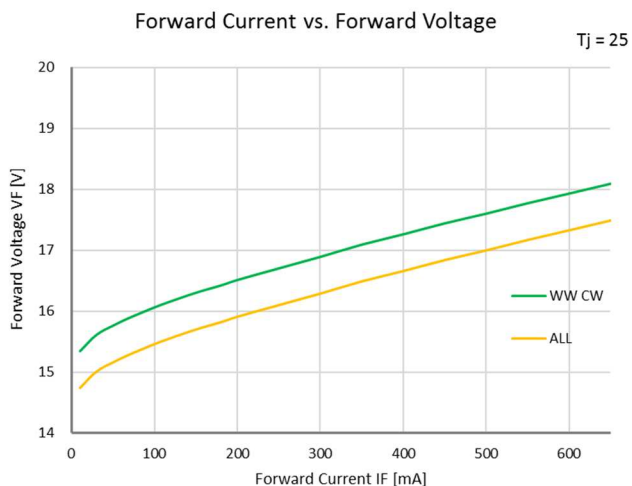
- COB mounting surface should be flat and plain.
- Substrate surface temperature should be uniform when measuring case temperature.

Thermal Resistance ($^{\circ}C/W$)

3.8 for BGX



3-5) Characteristics Diagram (TYP.)



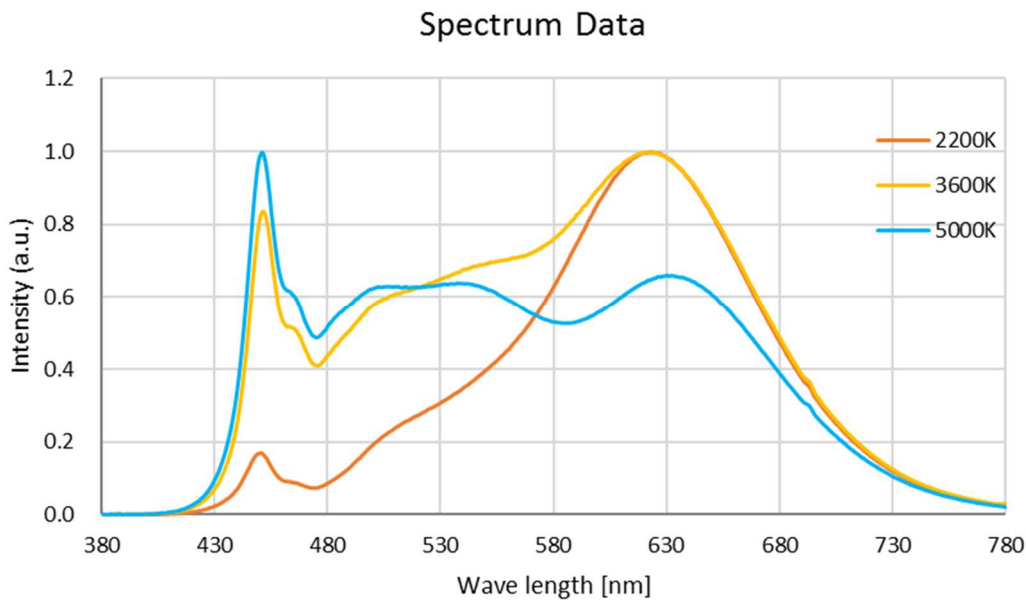
Notes:

- ※ 1. Temperature shown in above for Tc temperature at instantaneous operation, and Tj is equal to Tc for such operation. Please refer above chart as reference of temperature dependency of LED characteristics.
- ※ 2. Characteristics data shown here are for reference purpose only. (Not guaranteed data)

3-6) Spectrum and Color (Reference)

Spectrum data for 3000K, 4000K (Ra>90)

(Measured at 500mA, Tj=25°C)



※ Spectrum data shown here are for reference purpose only. (Not guaranteed data)

4. Reliability

The reliability of products shall be satisfied with items listed below.

NO	Test Item	Condition	Samples n	Defective C
1	Temperature Cycle	-40°C~100°C / Dwell time 30min / 300 Cycles	8	0
2	High Temperature / Humidity Storage	85°C/85%RH / 1000 H	8	0
3	Low Temperature Storage	-40°C / 1000 H	8	0
4	High Temperature Storage	100°C / 1000 H	8	0
5	High Temperature Life	Tc 85°C / 1000 H / @IF=500mA	8	0

Failure Criteria

(Measured at 500mA, Tj=25°C)

	Item	Symbol	Criteria
1	Forward Voltage	V _F	V _F > Initial value x 1.1
2	Luminous Flux	Φ	Φ < Initial value x 0.8
3	CIE-x / CIE-y	Δx, Δy	Δx, Δy < 0.02

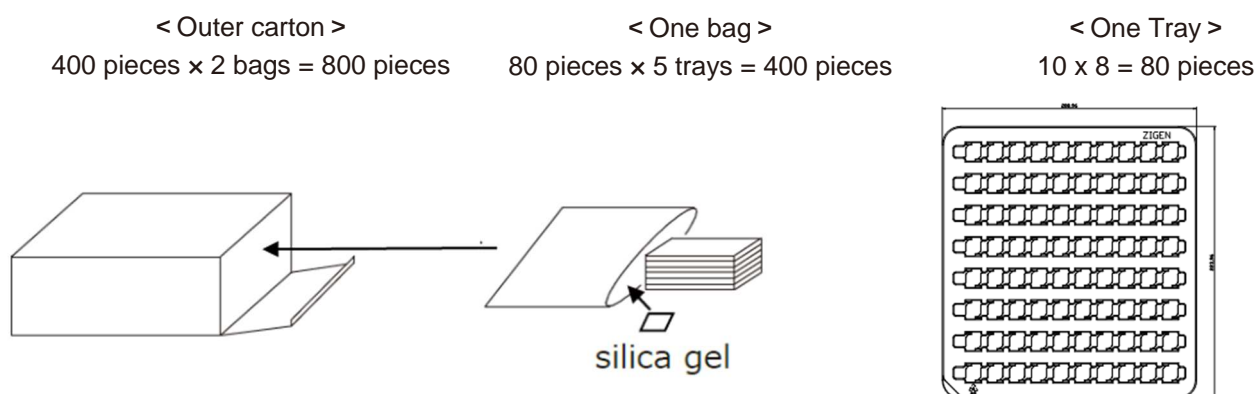
5. Packing and Labels

Packaging

- One tray composed of 80 pieces
- 5 trays (400 pieces) and one upper lid-tray in one moisture-proof bag
- 2 bags (800 pieces) in one carton
- Dimensions of outer carton : 235 × 220 × 90 mm (Reference value)

(Note 1) There are cases of one carton composed of one bag. (80 pieces~)

(Note 2) State of packing is subject to change.



Indication printed on product

Model No. and control No. are indicated on substrate surface.

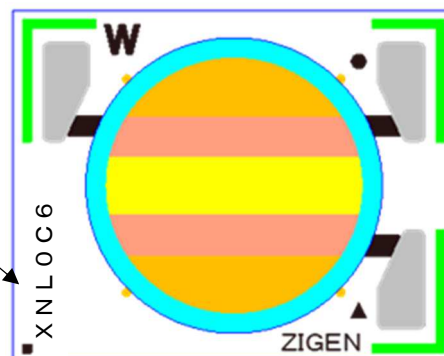
Control No.

Indicated as follows ;

XN L 9 G 4
 ① ② ③ ④ ⑤

- ① XN : Chip layout
(XN: 6series)
- ② L : Ra/Color code / rank
(L: 2200-5000K Ra90, 2: 2000-4000K Ra90)
- ③ 0 : Year
- ④ C : Month
- ⑤ 6 : Date (1~9,A~V)

Control Number



6. Precautions

1. Storage conditions

- Before the package is opened: The LEDs should be stored at 30°C or less and 50%RH or less after being delivered and the storage life limit is 6 months. If the LEDs are stored for 6 months or more, they should be stored in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- After opening the package: The LED should be stored under 30°C or less and 30%RH or less. The LED should be used within 7days after opening the package. If unused LEDs remain, it should be stored in moisture proof packages with absorbent.
- Please avoid exposing air with corrosive gas.

2. Handling of COB

- Do not put mechanical stress on the LED.
- Never touch the optical surface with finger or sharp object. The LED surface could be soiled or damaged, which could affect the optical performance of the LED.
- Please keep handling the LEDs with appropriate ESD grounding, especially in low-humidity work environment.
- It is recommended to handle the LED with powder-less latex gloves.
- Do not touch the resin with tweezers to avoid scratching or other damage.
- Please use IPA when cleaning COB

3. Assembly conditions

- Please use appropriate heatsink and thermal conductor (heat conductive glue/adhesive/sheet etc) for mounting COB to control Tc temperature.
- Please do not use convex or rough surface or not clean heatsink.
- Please make sure COB will not detach from heatsink through life of finish product.
- When using holder please avoid to use harmful outgas (Cl, Br etc) contain material (Br contain PBT etc) and make sure it's reliability is enough in temperature and light from COB.
- Please make sure thermal conductor on back side of LED will not reduce performance through life of finish product.
- Please avoid keep convex stress during and after installation, which may cause crack in long use.
- Please do not touch or hold by resin area and handle by ceramic substrate part only.

4. Connecting method

- Connection by solder wire with 380 degree tip-temperature tool under 5seconds is recommended.
- Please solder whole solder pad area.
- Please avoid to touch resin part by soldering tool.
- This product is not designed for reflow and flow soldering.
- Please prevent to pull lead connected to solder pad and pulling stress after installation.

- Please prevent to use flux.
- Please verify solder wire contented flux is no more activated after soldering.
- In case using holder connector, please verify electric connectivity for long use.

5. Usage conditions

- Please check reliability well enough under finish product condition before using for mass production.
- Please avoid use or verify reliability in a place with high moisture and corrosive gas (halogen, H₂S, NH₃, SO₂, NO_x etc)
- Please avoid use or verify reliability under direct sun right condition, exposure in outdoor and dusty place.
- Please avoid use or verify reliability to use in liquid like water, oil and solvent.
- Please avoid use under strong acidic or alkali atmosphere condition.

6. Operation

- Any reverse voltage cannot be applied after installation.
- Please use appropriate protective device to avoid surge or high voltage.

7. Safety

- Please be care to LED light from injuring eyes.
- Please avoid flammable goods from strong light intensity area.
- Please follow appropriate regulations and lows for usage as lighting product.

8. Others

- Any uncertain or necessity of suggestion in usage, please consult with sales representative.
- Please follow the latest assemble guide, available in the website of ZIGEN.
- All information in this document is subject to be updated without prior notice.
- Please confirm the latest datasheet with sales representative and exchange formal specification before starting purchase for mass production